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May 2024

FAN7361, FAN7362 **High-Side Gate Driver**

Features

- Floating Channel Designed for Bootstrap Operation to +600V
- Typically 250mA/500mA Sourcing/Sinking Current **Driving Capability**
- Common-Mode dv/dt Noise Canceling Circuit
- V_{CC} & V_{BS} Supply Range from 10V to 20V
- UVLO Function for V_{BS}
- Output In-phase with Input Signal
- 8-SOP

Applications

- PDP Scan Driver
- Motor Control
- SMPS
- Electronic Ballast

Description

The FAN7361/FAN7362, a monolithic high-side gate drive IC, can drive MOSFETs and IGBTs that operate up to +600V. Fairchild's high-voltage process and commonmode noise canceling techniques provide stable operation of the high-side driver under sign as the noise circumstances. An advanced level shint ircuit there high-side gate driver operation up $V_S = .9.8$ typ .or $V_{BS} = 15V$

The UVLO circuit rev. $_{5}$ malfunction when V_{BS} is lower than the specific this is a voltage of utput drivers typically urc ink 2 mA/500m/\, respectively, which is suitable of flu and later, ballast, PDP scan driver, nd so on

Ordering Information

Part Number	Package	Operating Temperature Range	© Eco Status	Packing Method
FAN7361M ⁽¹⁾				Tube
FAN7361MX ⁽¹⁾	8-SOP	-40°C ~ 125°C RoHS	Dalle	Tape & Reel
FAN7362M ⁽¹⁾			R0H5	Tube
FAN7362MX ⁽¹⁾				Tape & Reel

1. These devices passed wave soldering test by JESD22A-111.



For Fairchild's definition of Eco Status, please visit: http://www.fairchildsemi.com/company/green/rohs_green.html.

Typical Application Circuit

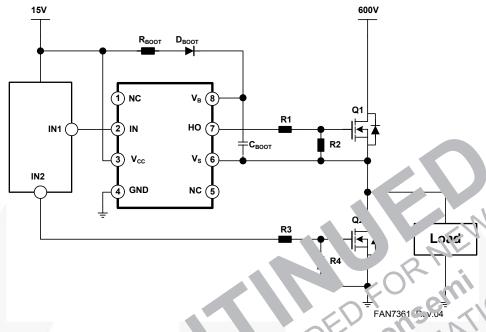


Fig 1. 1 vical A, lication Circuit

Internal Block Diagram

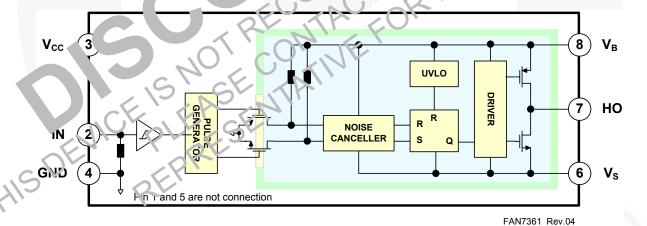


Figure 2. Functional Block Diagram

Pin Assignments

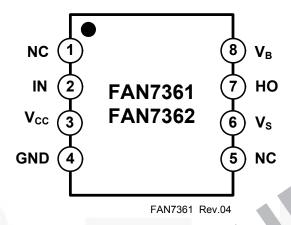


Figure 3. Pin Configuration (Top w)

Pin Definitions

Pin	Name	Fu ction/ Description
1	NC	No Connection
2	IN	Logic Input . h- de Gate Driver Culput
3	V _{CC}	Sti Jy v age
4	GND	Lu ic Grou
5	N′	No muon
6	V	F h-Voltage Floating Supply Return
7	110	ıgh-S'de Driver Ou.o∪
8		High-Side Floating Supply

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. $T_A=25^{\circ}C$, unless otherwise specified.

Symbol	Characteristics	Min.	Max.	Unit
V _S	High-Side Offset Voltage	V _B -25	V _B +0.3	
V_{B}	High-Side Floating Supply Voltage	-0.3	625	
V _{HO}	High-Side Floating Output Voltage	V _S -0.3	V _B +0.3	V
V _{CC}	Logic Fixed Supply Voltage	-0.3	25	
V _{IN}	Logic Input Voltage	-0.3	V _{CC} .s	
dV _S /dt	Allowable Offset Voltage Slew Rate		±	V/ns
P _D ⁽²⁾⁽³⁾⁽⁴⁾	Power Dissipation		625	V
θ_{JA}	Thermal Resistance, Junction-to-Ambient		200	°C.W
TJ	Junction Temperature		150	°C
T_S	Storage Temperature		+150	°C
T _A	Ambient Temperature	-40	125	°C

Notes:

- 2. Mounted on 76.2 x 114.3 x 1.6mm PCB (FR-4 class e, vy max al).
- 3. Refer to the following standards:
 - JESD51-2: Integral circuits thermal test vironmental conclitions Natural convection JESD51-3: Low effective therm convection vites poard for leaded surface mount backages
- 4. Do not exceed P_D under any clumstan s.

Recommen C erat g Conditions

The Recommended peraling Conditions table defines the conditions for actual device operation. Recommended operating and itions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommended them of designing to Absolute Maximum Ratings.

₹ymb	Pal'ameter	Min.	Max.	Unit
	'High Side Floating Supply Voltage	V _S +10	V _S +20	7
Ve	High-Side Floating Supply Offset Voltage	6-V _{CC}	600	
V _H O	High-Side Output voltage	V _S	V _B	V
S V _{IN}	Logic Input Voltage	GND	V _{CC}	
V _{CC}	Logic Supply Voltage	10	20	

Electrical Characteristics

 $V_{BIAS}(V_{CC}, V_{BS})$ =15.0V, T_A = 25°C, unless otherwise specified. The V_{IN} and I_{IN} parameters are referenced to GND. The V_O and I_O parameters are referenced to V_S and are applicable to the respective output HO.

Symbol	Characteristics	Test Conditi	on	Min.	Тур.	Max.	Unit
\/+	V _{BS} Supply Under-Voltage Positive Going	V _{BS} =Sweep	FAN7361	8.2	9.2	10.2	
V _{BSUV} +	Threshold	v _{BS} -Sweep	FAN7362	7.6	8.6	9.6	
V=====	V _{BS} Supply Under-Voltage Negative	V _{BS} =Sweep	FAN7361	7.4	8.6	9.2	V
V _{BSUV} -	Going Threshold	FAI	FAN7362	7.2	8.2	9.2	V
V	V _{BS} Supply Under-Current Lockout	V =Cwoon	FAN7361		0.5		
V _{BSHYS}	Hysteresis	V _{BS} =Sweep	FAN7362		7		
I _{LK}	Offset Supply Leakage Current	V _B =V _S =600V				10	
I_{QBS}	Quiescent V _{BS} Supply Current	V _{IN} =0V or 5V			50	80	
I _{QCC}	Quiescent V _{CC} Supply Current	V _{IN} =0V				75	μ/
I _{PBS}	Operating V _{BS} Supply Current	C _L =1nF, f=10kHz			420	.550	,
V _{IH}	Logic "1" Input Voltage		AN73	J.6		4	
VIН	Logic 1 input voitage		F. 176 2	2.3			
V_{IL}	Logic "0" Input Voltage		FAN7361			1.0	V
۷IL	Logic o input voltage		FAN7552			ე.გ	V
V _{OH}	High Level Output Voltage, V _B -V _{HO}	Nc ad		42		9.1	
V _{OL}	Low Level Output Voltage, V _{HC}	No Ic '	0		11	0.1	
I _{IN+}	Logic "1" Input Bias Current	′ _{!N} =5V			50	90	μA
I _{IN-}	Logic "0" Input Bias Cr ent	V _{IN} : 0/;			1.0	2.0	μΑ
I _{O+}	Output High Sh Sirc Pulse urrent	V _{HO} -0V, V _{I,1} =5V, PW	์ ≤ 1∂µร	200	250		mA
I _{O-}	Output Low Nort Circuit Luse Current	V _{HO} =15V, V _{IN} =0V PV.	/ ≤ 10μs	400	500		ША
Vs	Allor Net vive V Pin Voltage for IN Signal P gallor to HO	WELO.			-9.8	-7.0	٧

man : E etrical Characteristics

 V_{Bl} (V_C V_{BS})=15 GV V_S =GND, C_L =1000pi- and T_A = 25°C, unless otherwise specified.

Symool	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
t _{on}	Turn-on Propagation Dolay	V _S =0V		120	200	
t _{off}	Turn-off Propagation Delay ⁽⁵⁾	V _S =0V or 600V		90	180	no
t _r	Turn-on Rise Time			70	160	ns
t _f	Turn-off Fall Time			30	100	

Note:

5. This parameter guaranteed by design.

Typical Characteristics

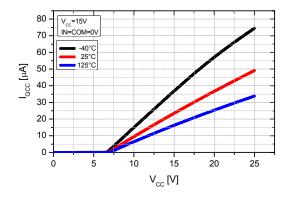
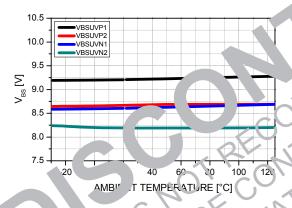


Figure 4. I_{QCC} vs. Supply Voltage



Figure 5. out B. Co. ent vs. Input Voltage



F. are 6. V_{BS} c'VLO vs. Τοιπρ.

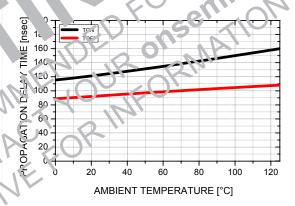


Figure 7. Turn On/Off Propagation Time vs. Temp.

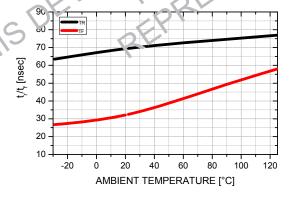


Figure 8. Rising/Falling Time vs. Temp.

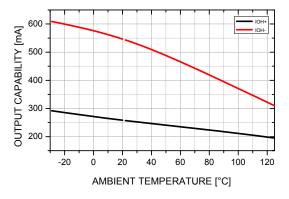


Figure 9. Output Sinking/Sourcing Current vs. Temp.

Switching Time Definition

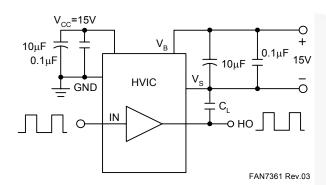
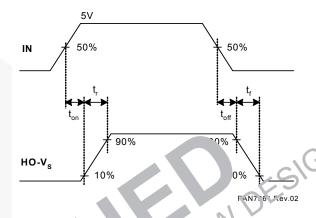
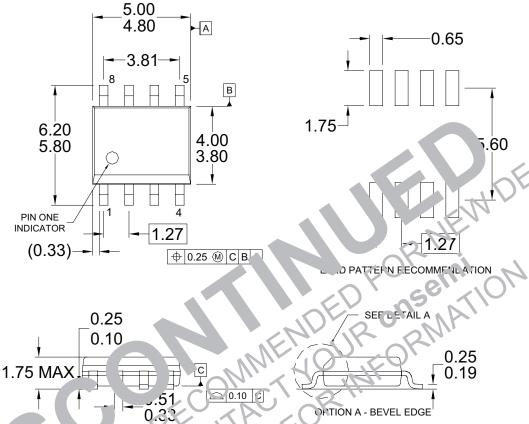


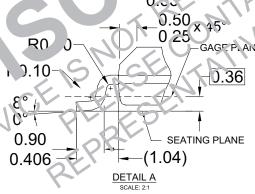
Figure 10. Switching Time Test Circuit



Fi re Inpu Output Tining Diagram

Physical Dimensions





OPTION B - NO BEVEL EDGE

NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO JEDEC MS-012, VARIATION AA, ISSUE C,
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS.
- D) LANDPATTERN STANDARD: SOIC127P600X175-8M.
- E) DRAWING FILENAME: M08AREV13

Figure 12. 8-Lead Small Outline Package (SOP)

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